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P-CHANNEL MOS FIELD EFFECT POWER TRANSISTOR

2SJ329

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SJ329 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

• Low On-state Resistance

 $R_{DS(on)} = 47 \text{ m}\Omega$ TYP. (Vgs = -10 V, ID = -8 A) $R_{DS(on)} = 80 \text{ m}\Omega$ TYP. (Vgs = -4 V, ID = -6 A)

- Low Ciss Ciss = 2 150 pF TYP.
- Built-in G-S Gate Protection Diodes

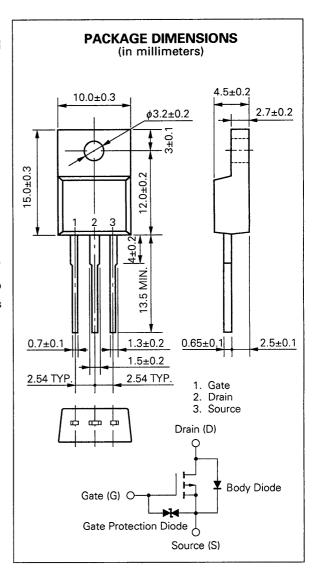
QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	VDSS	-60	٧
Gate to Source Voltage	VGSS(AC	∓20	٧
Gate to Source Voltage	VGSS(DC	-20, +10	V
Drain Current (DC)	ID(DC)	∓15	Α
Drain Current (pulse)	ID(pulse)*	∓60	Α
Total Power Dissipation (Tc = 25 °C)) PT1	35	W
Total Power Dissipation (Ta = 25 °C)	PT2	2.0	W
Channel Temperature	Tch	150 °C	MAX.
Storage Temperature	T _{stg}	-55 to +150	°C



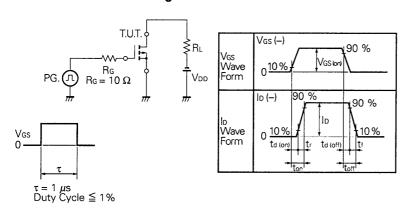
* PW \leq 10 μ s, Duty Cycle \leq 1 %



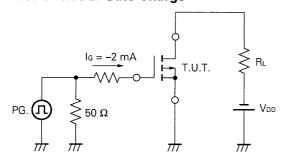
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-state Resistance	Ros(on)		47	60	mΩ	Vgs = -10 V, Ip = -8 A	
Drain to Source On-state Resistance	RDS(on)		80	110	mΩ	Vgs = -4 V, ID = -6 A	
Gate to Source Cutoff Voltage	V _{GS(off)}	-1.0	-1.5	-2.0	V	Vps = -10 V, lp = -1 mA	
Forward Transfer Admittance	y fs	8.0	12		s	Vps = -10 V, lp = -8 A	
Drain Leakage Current	loss			-10	μΑ	Vps = -60 V, Vgs = 0	
Gate to Source Leakage Current	Igss			∓10	μА	Vgs = ∓16 V, Vps = 0	
Input Capacitance	Ciss		2 150		pF	V _{DS} = -10 V V _{GS} = 0 f = 1 MHz	
Output Capacitance	Coss		1 100		pF		
Reverse Transfer Capacitance	Crss		530		pF		
Turn-On Delay Time	td(on)		35		ns	$V_{GS(on)} = -10 \text{ V}$ $V_{DD} = -30 \text{ V}$ $I_D = -8 \text{ A, Rg} = 10 \Omega$ $R_L = 3.8 \Omega$	
Rise Time	tr		150		ns		
Turn-Off Delay Time	td(off)		260		ns		
Fall Time	t _f		230		ns		
Total Gate Charge	QG		80		nC	V _{GS} = −10 V	
Gate to Source Charge	Qgs		6		nC	lo = -15 A	
Gate to Drain Charge	Q _{GD}	,	35		nC	V _{DD} = -48 V	
Diode Forward Voltage	Vsp		1.0		٧	Ir = 15 A, Vgs = 0	
Reverse Recovery Time	trr		120		ns	I _F = 15 A, V _{GS} = 0 di/dt = 50 A/μs	
Reverse Recovery Charge	Qrr	-	260		nC		

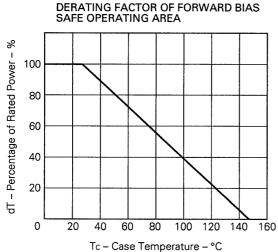
Test Circuit 1: Switching Time

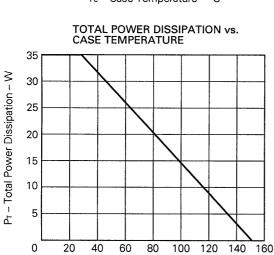


Test Circuit 2: Gate Charge

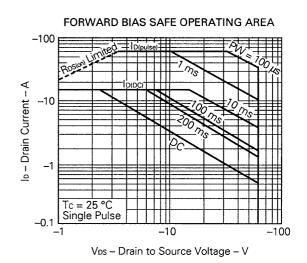


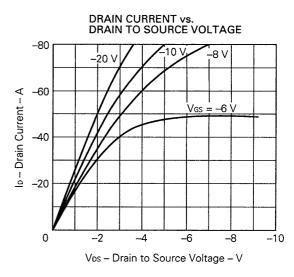
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

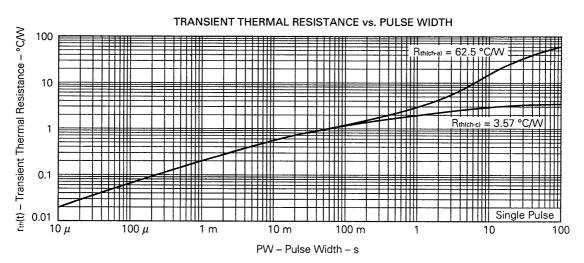


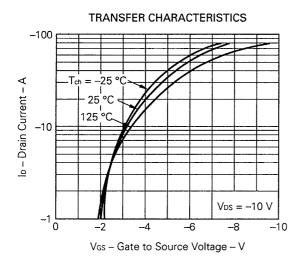


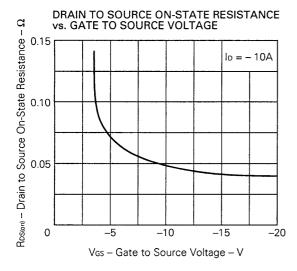
Tc - Case Temperature - °C

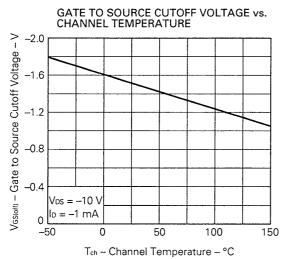


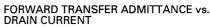


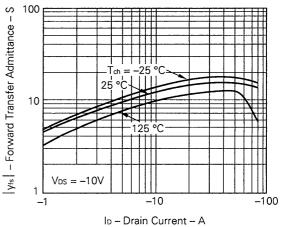




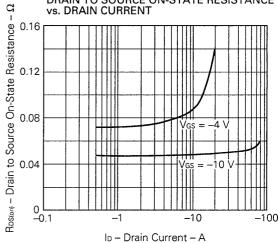




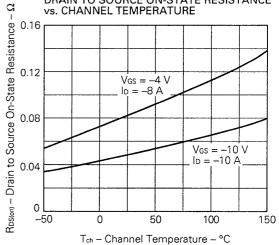


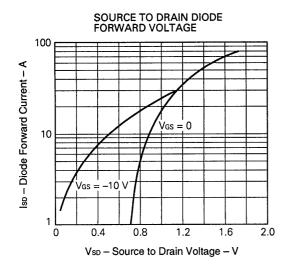


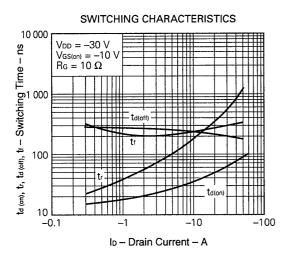
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

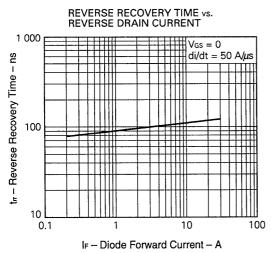


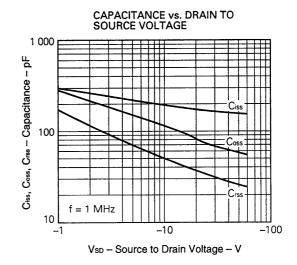
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

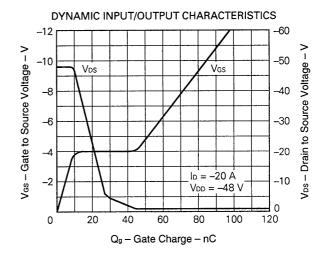












Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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